SPDT, 1 Ω R_{ON} Switch

The NLAS5123 is a low R_{ON} SPDT analog switch. This device is designed for low operating voltage, high current switching of speaker output for cell phone applications. It can switch a balanced stereo output. The NLAS5123 can handle a balanced microphone/speaker/ringtone generator in a monophone mode. The device contains a break-before-make (BBM) feature.

Features

- Single Supply Operation:
 - 1.65 V to 5.5 V V_{CC}
- Function Directly from LiON Battery
- R_{ON} Typical = 1.0 Ω @ V_{CC} = 4.5 V
- Low Static Power
- This is a Pb-Free Device

Typical Applications

- Cell Phone Speaker/Microphone Switching
- Ringtone-Chip/Amplifier Switching
- Stereo Balanced (Push-Pull) Switching

Important Information

- Continuous Current Rating Through each Switch ±300 mA
- 1.2 x 1.0 x 0.4P mm 6-Lead Thin DFN Package



ON Semiconductor®

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MARKING DIAGRAM

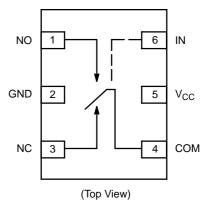


W = Specific Device Code

M = Date Code & Assembly Location

= Pb-Free Device

PIN ASSIGNMENTS



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

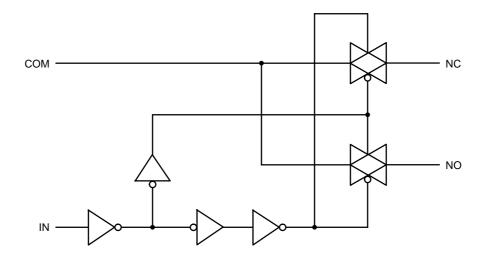


Figure 1. Input Equivalent Circuit

PIN DESCRIPTION

Pin Name	Description
NC, NO, COM	Data Ports
IN	Control Input

TRUTH TABLE

Control Input	Function
L	NC Connected to COM
Н	NO Connected to COM

H = HIGH Logic Level. L = LOW Logic Level.

MAXIMUM RATINGS

Symbol	Rating	Value	Unit
V _{CC}	Positive DC Supply Voltage	-0.5 to +6.0	V
V _{IS}	Analog Input Voltage (V _{NO} , V _{NC} , or V _{COM})	–0.5 to V _{CC} +0.5	V
V _{IN}	Digital Select Input Voltage	-0.5 to +6.0	V
I _{anl1}	Continuous DC Current from COM to NC/NO	±300	mA
I _{anl-pk1}	Peak Current from COM to NC/NO, 10 Duty Cycles (Note 1)	±500	mA
I _{clmp}	Continuous DC Current into COM/NC/NO with respect to V_{CC} or GND	±100	mA

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Rating	Min	Max	Unit	
V _{CC}	Positive DC Supply Voltage		1.65	5.5	V
V _{IS}	Analog Input Voltage (NC, NO, COM)		0	V _{CC}	V
V _{IN}	Digital Select Input Voltage (IN)		0	V _{CC}	V
T _A	Operating Temperature Range		-40	85	°C
t _r , t _f		_{CC} = 3.0 V _{CC} = 5.5 V		20 10	ns/V

^{1.} Defined as 10% ON, 90% off duty cycle.

DC ELECTRICAL CHARACTERISTICS

			V _{CC}	$T_A = +25^{\circ}C$		С	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		
Symbol	Parameter	Test Conditions	(V)	Min	Тур	Max	Min	Max	Unit
V _{IH}	HIGH Level Input Voltage		2.7 4.5				2.0 2.4		V
V _{IL}	LOW Level Input Voltage		2.7 4.5					0.6 0.8	V
I _{IN}	Input Leakage Current	$0 \le V_{IN} \le 5.5 V$	0-5.5			±0.1		±1	μΑ
I _{OFF}	OFF State Leakage Current (Note 7)	$0 \le NO, NC, COM \le V_{CC}$	5.5	-2.0		+2.0		±20	nA
I _{ON}	ON State Leakage Current (Note 7)	$0 \le NO, NC, COM \le V_{CC}$	5.5	-4.0		+4.0		±40	nA
R _{ON}	Switch On Resistance (Note 2)	$I_O = 100 \text{ mA},$ $V_{IS} = 0 \text{ V to V}_{CC}$	2.7			1.7		2.0	Ω
		I _O = 100 mA, V _{IS} = 0 V to V _{CC}	4.5			1.0		1.2	
I _{CC}	Quiescent Supply Current All Channels ON or OFF	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$	5.5			0.5		1.0	μΑ
Analog Signal Range									
ΔR_{ON}	On Resistance Match	I _A = 100 mA,	2.7		0.15				Ω

ΔR _{ON}	On Resistance Match Between Channels (Notes 2, 3, 4)	I _A = 100 mA, V _{IS} = 1.5 V I _A = 100 mA, V _{IS} = 2.5 V	2.7 4.5	0.15 0.12		0.15	Ω
R _{flat}	On Resistance Flatness (Notes 2, 3, 5)	$ I_{A} = 100 \text{ mA}, \\ V_{IS} = 0 \text{ V to V}_{CC} \\ I_{A} = 100 \text{ mA}, \\ V_{IS} = 0 \text{ V to V}_{CC} $	2.7 4.5	0.4		0.4	Ω

^{2.} Measured by the voltage drop between NC/NO and COM pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (NO, NC, COM).

Parameter is characterized but not tested in production.
 ΔR_{ON} = R_{ON} max – R_{ON} min measured at identical V_{CC}, temperature and voltage levels.
 Flatness is defined as the difference between the maximum and minimum value of On Resistance over the specified range of conditions.

^{6.} Guaranteed by Design.

^{7.} This parameter is guaranteed by design but not tested. The bus switch contributes no propagation delay other than the RC delay of the On Resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance).

AC ELECTRICAL CHARACTERISTICS

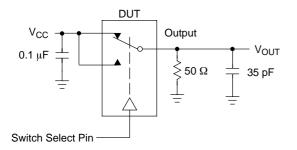
			V _{CC}	T,	_A = +25°	С	T _A = -40°	C to +85°C		Figure
Symbol	Parameter	Test Conditions	(V)	Min	Тур	Max	Min	Max	Unit	#
t _{PHL} t _{PLH}	Propagation Delay Bus-to-Bus (Note 9)	$V_{IN} = V_{IH}$ or V_{IL}	2.7 4.5			2.0 0.3			ns	
t _{ON}	Output Enable Time Turn On Time (COM to NO or NC)	$V_{IS} = 1.5 \text{ V},$ $R_L = 50 \Omega, C_L = 35 \text{ pF}$ $V_{IS} = 3.0 \text{ V},$ $R_L = 50 \Omega, C_L = 35 \text{ pF}$	2.7 4.5			30 20		35 25	ns	3, 4
t _{OFF}	Output Disable Time Turn Off Time (COM to NO, NC)	$V_{IS} = 1.5V$, $R_L = 50 \Omega$, $C_L = 35 pF$ $V_{IS} = 3.0 V$, $R_L = 50 \Omega$, $C_L = 35 pF$	2.7 4.5			20 15		25 20	ns	3, 4
t _{BBM}	Break Before Make Time (Note 8)	$V_{IS} = 1.5V$, $R_L = 50 \Omega$, $C_L = 35 pF$	2.7 4.5	0.5			0.5 0.5		ns	2
Q	Charge Injection (Note 8)	$C_L = 1.0 \text{ nF}, V_{GEN} = 0 \text{ V}$ $R_{GEN} = 0 \Omega$	2.7 4.5	0.0	26 48		0.0		pC	6
O _{IRR}	Off Isolation (Note 10)	$R_L = 50 \Omega$ f = 1.0 MHz	2.7 – 5.5		-62				dB	5
X _{talk}	Crosstalk	$R_L = 50 \Omega$ f = 1.0 MHz	2.7 – 5.5		-70				dB	7
BW	-3 dB Bandwidth	R _L = 50 Ω	2.7 – 5.5		55				MHz	8
THD	Total Harmonic Distortion (Note 8)	$R_L = 600 \Omega$ 0.5 V_{P-P} f = 20 Hz to 20 kHz	2.7 – 5.5		0.012				%	9

CAPACITANCE (Note 11)

Symbol	Parameter	Test Conditions	Тур	Max	Unit
C _{IN}	Select Pin Input Capacitance	V _{CC} = 0 V, f = 1 MHz	2.0		pF
C _{NC/NO}	NC, NO Port Off Capacitance	V _{CC} = 4.5 V, f = 1 MHz	20		pF
C _{COM}	COM Port Capacitance when Switch is Enabled	V _{CC} = 4.5 V, f = 1 MHz	55		pF

^{11.} $T_A = +25$ °C, f = 1 MHz, Capacitance is characterized but not tested in production.

Guaranteed by Design.
 This parameter is guaranteed by design but not tested. The bus switch contributes no propagation delay other than the RC delay of the On Resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance).
 Off Isolation = 20 log₁₀ [V_{COM}/V_{NO,NC}].



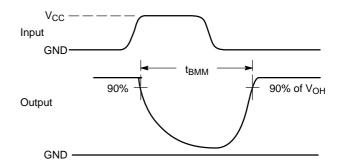
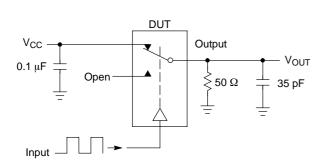


Figure 2. t_{BBM} (Time Break–Before–Make)



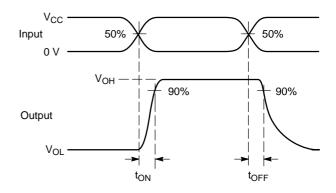
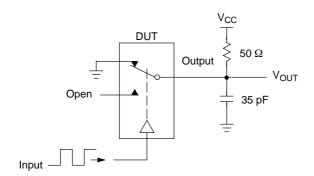


Figure 3. t_{ON}/t_{OFF}



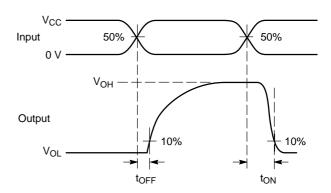
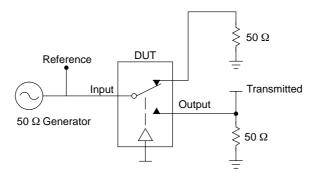


Figure 4. t_{ON}/t_{OFF}



Channel switch control/s test socket is normalized. Off isolation is measured across an off channel. On loss is the bandwidth of an On switch. $V_{\rm ISO}$, Bandwidth and $V_{\rm ONL}$ are independent of the input signal direction.

$$V_{ISO}$$
 = Off Channel Isolation = 20 Log $\left(\frac{V_{OUT}}{V_{IN}}\right)$ for V_{IN} at 100 kHz

$$V_{ONL}$$
 = On Channel Loss = 20 Log $\left(\frac{V_{OUT}}{V_{IN}}\right)$ for V_{IN} at 100 kHz to 50 MHz

Bandwidth (BW) = the frequency 3 dB below V_{ONL}

 V_{CT} = Use V_{ISO} setup and test to all other switch analog input/outputs terminated with 50 Ω

Figure 5. Off Channel Isolation/On Channel Loss (BW)/Crosstalk (On Channel to Off Channel)/V_{ONL}

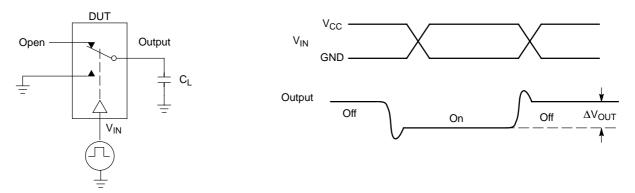


Figure 6. Charge Injection: (Q)

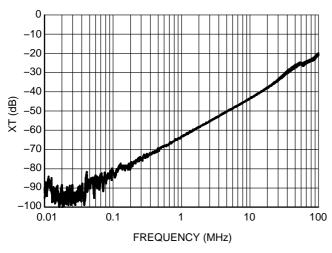


Figure 7. Cross Talk vs. Frequency
@ V_{CC} = 4.5 V

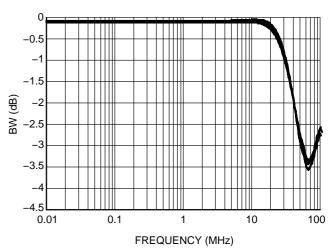


Figure 8. Bandwidth vs. Frequency

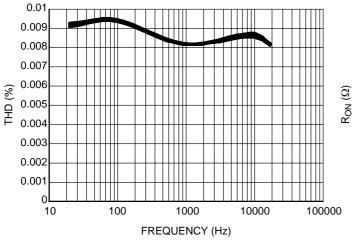


Figure 9. Total Harmonic Distortion

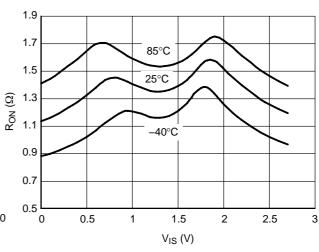


Figure 10. On–Resistance vs. Input Voltage @ V_{CC} = 2.7 V

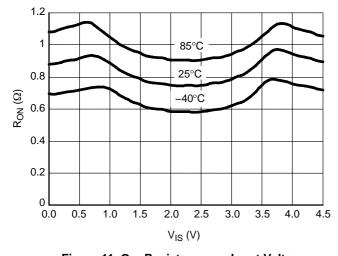


Figure 11. On–Resistance vs. Input Voltage @ V_{CC} = 4.5 V

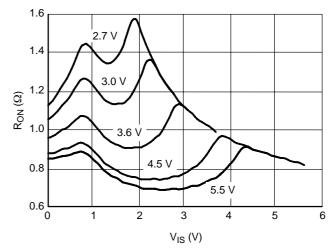


Figure 12. On-Resistance vs. Input Voltage

DEVICE ORDERING INFORMATION

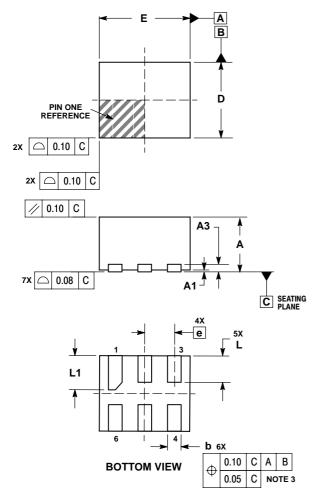
Device Order Number	Circuit Indicator	Technology	Device Function	Package Suffix	Tape & Reel Suffix	Package Type	Tape & Reel Size [†]
NLAS5123MNR2G	NL	AS	5123	MN	2	WDFN6 (Pb-Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

WDFN6

CASE 506AS-01 ISSUE A

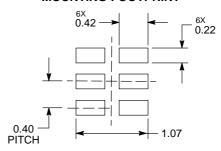


NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. DIMENSION b APPLIES TO PLATED
- DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30mm FROM TERMINAL.
- . COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS						
DIM	MIN	MAX					
Α	0.70	0.80					
A1	0.00	0.05					
A3	0.20 REF						
b	0.15	0.25					
D	1.00) BSC					
E	1.20	BSC					
е	0.40	BSC					
L	0.30	0.40					
12	0.40	0.50					

MOUNTING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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